

SPECIFICATION

PRODUCT NO. : XT18033A

VERSION : Ver 1.5

2020 -03- 25

ISSUED DATE : 2020-03-25

This module uses ROHS2 material

FOR C	USTO	MER:	
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- \Box : APPROVAL FOR SPECIFICATION
- **■**: APPROVAL FOR SAMPLE

DATE	APPROVED BY

Xinli Optoelectronics:

Presented by	Reviewed by	Organized by
(密美本	Twicky	爱油料

Note

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1. Revision Recode

Revision	Description	Date
1.0	Initial Release	2019/09/19
1.1	Change the Mechanical Dimension	2019/09/27
1.2	Update data	2019/12/20
1.3	Optimization specification	2020/02/07
1.4	Change the Mechanical Dimension	2020/2/19
1.5	Change the Backlight Characteristics and Add insulation	2020/3/25
1.3	tape appearance standard	2020/3/23
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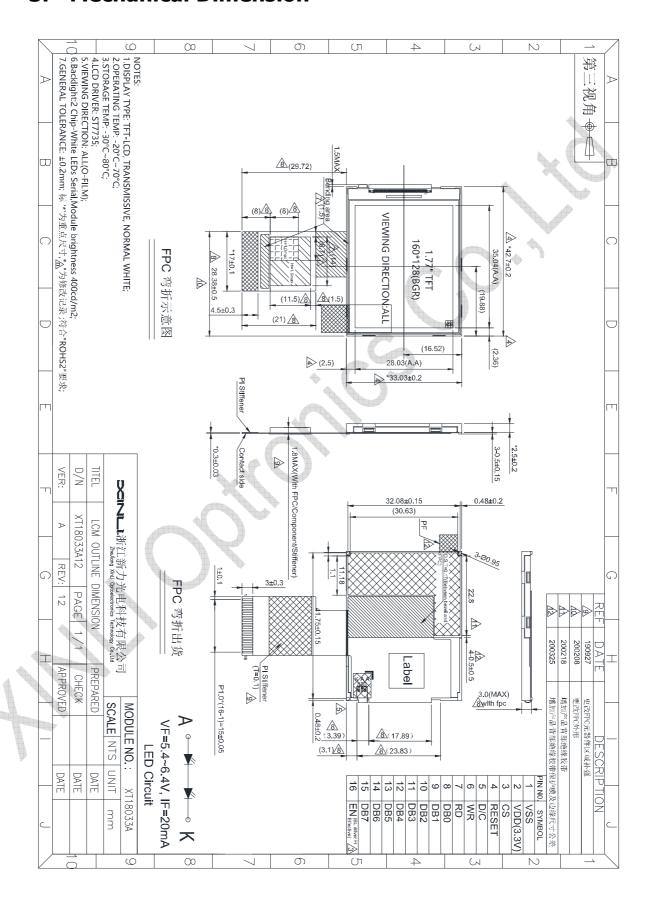
2. General Description and Features

The 1.8 inch Module named XT18033A is a-Si TFT-LCD module, which is the type of transmissive. It is consisted of TFT-LCD Panel, Driver IC, FPC and Back-Light unit. Features of this product are listed in the following table.

NO	Item	Contents	Unit
(1)	Module Outsize	33.03*42.7*2.5	mm
(2)	LCD Active area	28.03*35.04	mm
(3)	Dot Number	128*3(RGB)*160	
(4)	Dot size	0.198*0.198	mm
(5)	LCD type	TFT Transmissive	/
(6)	Display Color	256	/
(7)	Viewing direction	ALL(O-FILM)	O'clock
(8)	Backlight Type	2-chip LEDs	/
(9)	Power Supply	3.3 (TYP)	V
(10)	IC	ST7735	/
(11)	Interface	FPC 1.0mm_Pitch 16 pin	1
(12)	Interface type	MCU	1
(13)	Module weight	6.9	g



3. Mechanical Dimension



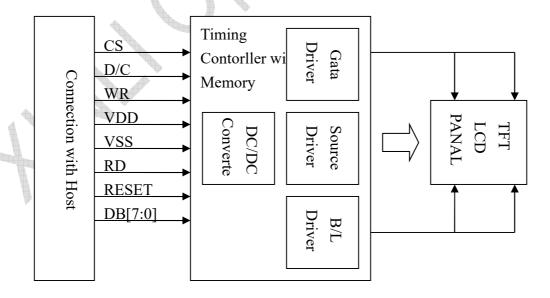


4. Interface Pin Connection

LCM interface Pin

NO	Symbol	Level	Description
1	VSS	P	Power ground
2	VDD	P	Power voltage
3	CS	I	Chip selection pin
4	RESET	P	Reset signal of the driver IC
5	D/C	I	Display data/command selection pin in parallel
			interface.
6	WR	I	Write enable in MCU parallel interface.
7	RD	I	Read enable in 8080 MCU parallel interface.
8	DB0	I	DATA BUS
9	DB1	I	DATA BUS
10	DB2	I	DATA BUS
11	DB3	I	DATA BUS
12	DB4	I	DATA BUS
13	DB5	I	DATA BUS
14	DB6	I	DATA BUS
15	DB7	I	DATA BUS
16	EN(B/L)	I,	B/L Enable

5. Block Diagram





6. Maximum Rating

Item	Symbol	Rating	Unit
Operating temperature	Тор	-20 to 70	°C
Storage temperature	Tst	-30 to 80	°C
Booster power supply	VDD	-0.3V ~ 4.5	V

7. Electrical Characteristics

Item		Symbol	Condition Min.		Тур.	Max.	Unit
Analog powe	r supply	VDD	-	3.0	3.3	3.6	V
Logic input signal Voltage	H level	V_{IHI}		0.7*VDD 0.8*VDD		VDD	V
	L level	$V_{_{\rm IL1}}$	-	0	1	0.3*VDD 0.2*VDD	V
Logic output	H level	$V_{ ext{oh}}$		0.9*VDD	-	VDD	V
signal Voltage	L level	Vol		0	ı	0.1*VDD	V

8. Backlight Characteristics

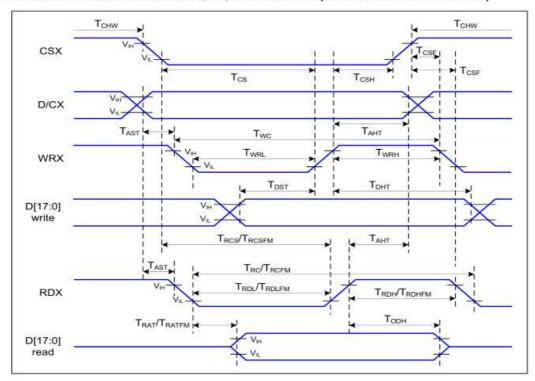
Item	syb	Min	Тур	Max	Unit	Condition
Voltage	Vf	_	5.6	-	V	IF=20mA
Number of LED			2		pcs	-
Power Consumption	PWF	118.8	123.2	149.6	mW	-
Connection mode	P	Series connection			-	-
LED lifetime	-	(20000)	-	-	Hrs	25℃, If=20mA,60%RH

LED lifetime is when the brightness decays to 50%



9. Timing Characteristics

Parallel Interface Characteristics: 18, 16, 9 or 8-bit Bus (8080 Series MCU Interface)

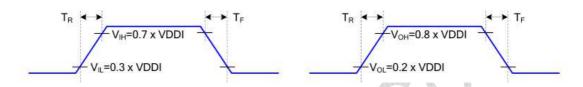


Ta=25 °C, VDDI=1.65~3.7V, VDD=2.5~3.7V

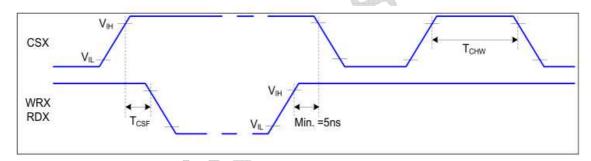
Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	TAST	Address Setup Time	0		ns	
D/CX	TAHT	Address Hold Time (Write/Read)	10		ns	-
	TCHW	Chip Select "H" Pulse Width	0		ns	
	TCS	Chip Select Setup Time (Write)	15		ns	
Cev	TRCS	Chip Select Setup Time (Read ID)	45		ns	
CSX	TRCSFM	Chip Select Setup time (Read FM)	355		ns	-
	TCSF	Chip Select Wait Time (Write/Read)	10		ns	
	TCSH	Chip Select Hold Time	10		ns	
	TWC	Write Cycle	66		ns	
WRX	TWRH	Control Pulse "H" Duration	15		ns	
	TWRL	Control Pulse "L" Duration	15		ns	
	TRC	Read Cycle (ID)	160		ns	
RDX (ID)	TRDH	Control Pulse "H" Duration (ID)	90		ns	When Read ID Data
	TRDL	Control Pulse "L" Duration (ID)	45		ns	



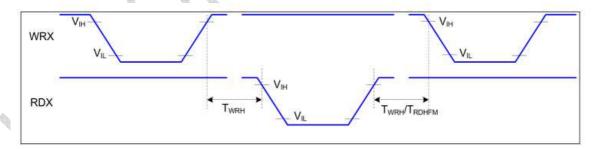
RDX	TRCFM	Read Cycle (FM)	450		ns	When Read from
(FM)	TRDHFM	Control Pulse "H" Duration (FM)			ns	
(FIVI)	TRDLFM	Control Pulse "L" Duration (FM)	355		ns	Frame Memory
	TDST	Data Setup Time	10		ns	
	TDHT	Data Hold Time	10		ns	
D[17:0]	TRAT	Read Access Time (ID)		40	ns	For CL=30pF
	TRATFM	Read Access Time (FM)		340	ns	
	TODH	Output Disable Time	20	80	ns	



Rising And Falling Timing for Input And Output
Signal



Chip Selection (CSX) Timing



Write-to-Read And Read-to-Write Timing

10. Application Circuit

Please consult our technical department for detail information.

11. Initial Code

Please consult our technical department for detail information.



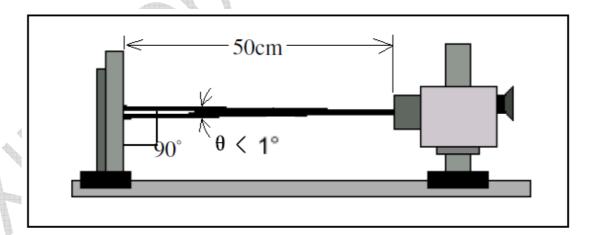
12. Electro-Optical Characteristics

Item		Symbol	Condition	Min	Тур	Max	Unit	Note
Transmission (w	ith pol)	T		-	6.9	-	%	
Response tim	ne	Tr+Tf	θ=0°	-	30	-	ms	4
Uniformity		δ	Ø=0°	-	80	-	%	7
(Five point))	WHITE	Ta=25°C					A
Contrast rati	o	Cr		-	300	-	- 1	3,5
Surface Lumin	ance	Lv		-	400	-	-	3,7
			Ø = 90°	-	45	-	deg	6
Viewing angle r	ange	θ	Ø = 270°	-	45		deg	
			$\emptyset = 0$ °	-	20	-	deg	
			Ø = 180°	ı	45	-	deg	
Color filter		X	<i>θ</i> =0°	0.2629	0.3029	0.3429		_
chromaticity (x, y)	White	Y	Ø=0°	0.2785	0.3185	0.3585		7

Note 1: Ambient temperature=25 ℃±2 ℃

Note 2: To be measured in the dark room with backlight unit.

Note 3: To be measured at the center area of panel with a viewing cone of 1 by Topcon luminance meter BM-7A, after 10 minutes operation (module).

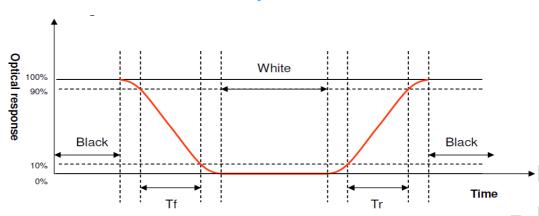


Note 4: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (rising time) and from "white" to "black" (falling time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes.

Refer to figure as below.





Note 5. Definition of contrast ratio:

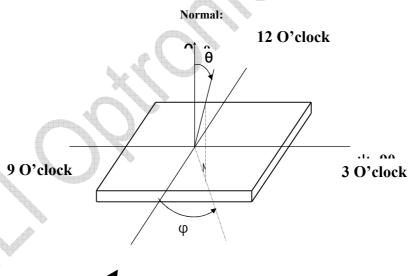
Contrast ratio is calculated with the following formula:

Contrast ratio (CR) =
Photo detector output when LCD is at "White" state

Photo detector output when LCD is at "Black" state

Note 6. Definition of viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10 for TFT module. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface.

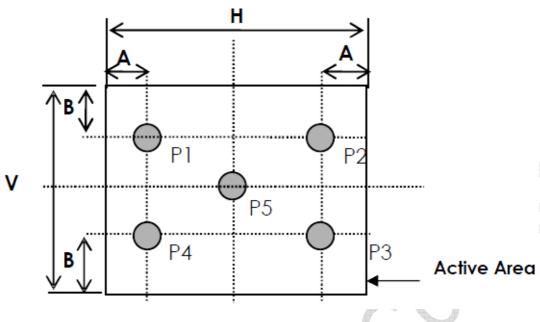


6 O'clock

Note 7. Surface luminance is the LCD surface from the surface with all pixels displaying white. Refer to figure as below.

Measuring method for Contrast ratio, surface luminance, Luminance uniformity, $\,$ CIE (x,y) chromaticity





A:5 mm B:5 mm H,V: Active Area

Light spot size Æ=7mm, 500mm distance from the LCD surface to detector lens measurement instrument is TOPCON's luminance meter BM-7A

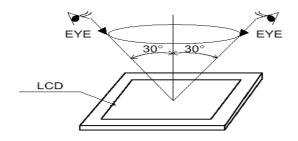
Uniformity definition= [min of 5point/max of 5points]x100% Lv = Average Surface Luminance with all white pixels (P₁, P₂, P₃, P₄, P₅)

13. Quality Assurance

The customer should check and accept the products of XINLI within one month after reception. This standard for Quality Assurance should affirm the quality of LCD products to supply to purchaser by XINLI Company Limited.

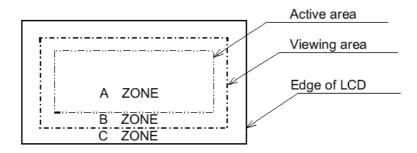
1. Appearance Inspection

- (1) Ambient illumination condition need 750lux for visual cosmetic inspection (300lux for Electrical characteristic functional inspection.)
- (2) The distance from eyes to LCD must be 30cm.
- (3) Viewing direction must be within 30 degrees to vertical line of LCD center.





2. Definition of A zone, B zone and C zone



B ZONE: A ZONE and 1/2 BM

3. Appearance Criterion

Item No.	Items to be inspected	Inspection standard		
3.1	LCD black spots, white spots,	Defect Type Acceptable QTY		
	color spots	Bright Dots 1		
		Dark Dots 2		
		Total Bright and 3		
		Dark Dots		
		The definition of dot: The size of a defective dot over 1/2 of		
		whole dot is regarded as one defective dot.		
		Bright dot: Dots appear bright and unchanged in size in		
		which LCD panel is displaying under black pattern.		
		The bright dot defect must be visible through 2% ND filter Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern. The size of a defective dot less than 1/2 dot is no count		



		2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	optionies Ct	31, Eta		
3.2	Spot Defect	Define:				
	(Including:	(a=(ax xx)/2				
	Black spot,	$\varphi = (x+y)/2$				
	White spot,	X_{-1}	\			
	Pinhole, Foreigh	—	<u> </u>			
	particle,		▼ Y			
	Polarizer dirl)					
		Size	e φ (mm)		Acceptal	ble QTY
		φ	≤ 0.20		Ign	ore
		0.20	$\leq \varphi \leq 0.30$		3	
		Space be	etween>5mm			
		0	.30<φ		Not al	lowed
		Ignore the s	pot distance v	vhile defe	ct is in sp	ec.
		The distanc	e between two	spot sho	uld be lar	ger than 20mm.
3.3	Line Defect	Define:				
	(Including:		*			
	Black spot,	_		/-	W	
	White spot,					
	Pinhole, Foreigh		L			
	particle, Polarizer dirl)	Length	Width	Accepta	ble QTY	Remark
	Polarizer diri)			A.A	V.A	
		-	W ≤ 0.02	Ignore	Ignore	
		L≦2.5	0.02< W≦			No
			0.05			more than
				3	4	two lines
						within
						20mm
			0.03< W	0	0	
		Ignore the s	pot distance v	vhile defe	ct is in sp	ec.
		The distance between two line should be larger than 20mm.				
3.4	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not				
		easy to find, must check in specify direction.				
L						



		Acceptable QTY			
		;	Size	A.A	V.A
		φ≤0.20		Ignore	Ignore
		0.20<φ≦0	0.40	3	5
		0.40<φ		0	0
				hile defect is in s	
			e between two	bubble should be	e larger than
2.5	I	20mm.			
3.5	Insulating tape of	Define:			A A
	Bezel	$\varphi = (x+y)/2$		()	
		X	$\frac{\downarrow}{}$		
		Define:			
		L			
		Size φ (mm) Acceptable QTY			
		φ	5≦1.5	Ig	nore
		1.5<φ Not allowed			allowed
		Length	Width	Acceptable QTY	Remark
		L≦4	-	Ignore	
		4 <l< th=""><th></th><th>Not allowed</th><th></th></l<>		Not allowed	
3.6	Mini Electrical Dot Defect	Not accepted under 5% ND filter.			
3.7	Mura (Non-uniformity)	Not accepted under 5% ND filter, but a limits sample will be allowed.			



		Xinii Optronics Co., Lt	
3.8	FPC	Broken	Not allowed
		Crease	Can't see the white crease
3.9	Bezel	Rust	
		oil	NG
		Broken(Affect the assembly)	
3.10	Chipped glass	Symbols:	X
		a: Chip length b: Chip width	c: Chip thickness
		t: Glass thickness	
		1 ITO electrode	-0"
		a<=t b<=0.5mm	.1
		c<=3.0mm	
			· ·
		2 General, corner portion	
		a<= t	b I a
		b<=1.0mm	
		c<=5.0mm	
			D a
		t	
Ψ'			J
		*Effective width of seal area shall be	more than 0.3mm.



		Anni Optionies Co., Eta
		b c
3.11	Cracked glass	The LCD with extensive crack is not acceptable.
3.12	Backlight elements	1 Illumination source flickers when lit.2 Spots or scratches that appear when lit must be judged using
		LCD spot, lines and contamination standards.
		3 Backlight doesn't light or color is wrong
3.13	Soldering	1 No unmelted solder paste may be present on the PCB.
		2 No cold solder joints, missing solder connections, oxidation
		or icicle.
		3 No residue or solder balls on PCB.
		4 No short circuits in components on PCB.
3.14	General	1 No oxidation, contamination, curves or, bends on interface
	appearance	pin (OLB) of TCP.
		2 No cracks on interface pin(OLB) of TCP
		3 NO contamination, solder residue or solder balls on product.
		4 The IC on the TCP may not be damaged, circuits.
		5 The residual rosin or tin oil of soldering (component or chip
		component) is not burned into brown or black color.
		6 Sealant on top of the ITO circuit has not hardened
		7 Pin type must match type in specification sheet.
		8 LCD pin loose or missing pins.
		9 Product packaging must the same as specified on packaging



		specification sheet.
		10 Product dimension and structure must conform to product
		specification sheet.
3.15	Mura	Not accepted under 5% ND filter,but a limits sample will be
	(Non-uniformity)	allowed.
3.16	Mura	Extreme light leakage is not acceptable.
	(Light Leakage)	

14. Reliability Test

This standard reliability test is done only for the first lot of MP products. Customer and supplier must hold a discussion if other reliability test is requested by customer.

NO.	Test Item	Description	Test Condition
1	High temperature storage	Endurance test applying the high storage temperature for a long time	80°C,96 H
2	Low temperature storage	Endurance test applying the low storage temperature for a long time	-30°С,96Н
3	High temperature operation	Endurance test applying the electric stress under high temperature for a long time	70°C,96H
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time	-20°C,96H



5	High temperature /humidity storage	Endurance test applying the high temperature and high humidity storage for a long time	60℃,90% RH, 96H
6	High temperature /humidity operation	Endurance test applying electric stress under high temperature and high humidity for a long time	70℃,80%RH, 96H
7	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}\text{C} \leftarrow \rightarrow 25^{\circ}\text{C} \leftarrow \rightarrow 70^{\circ}\text{C}$ 30min $\leftarrow \rightarrow 5$ min $\leftarrow \rightarrow 30$ min one cycle	-20°C/70°C, 10 cycles
8	ESD Test	To check the product operating capability after electrostatic environment.	Voltage: ± 2KV(contact discharge); ±4 KV(air discharge)

15. Precautions for Operation and Storage

1. Precautions for Operation

(1)Since LCD panel made of glass,in order to prevent from glass broken or color tone change,please do not apply any mechanical shock or impact or excessive

force to it when installing the LCD module.

- (2)If LCD panel is broken and liquid crystal substance leaks out and contact your skin or clothes, please immediately wash it off by using soap and water.
- (3) The polarizer on the LCD surface is soft and easily scratched. Please be careful when handling.
- (4)If LCD surface becomes contaminated, please wipe it off gently by using moisten soft cloth with normal hexane, do not use acetone, ketone, ethanol, alcohol or water. If there is saliva or water on the LCD surface, please wipe it off immediately.
- (5) When handing LCD module, please be sure that the body and the tools are properly grounded. And do not touch I/F pins with bare hands or contaminate I/F pins.
- (6)Do not attempt to disassemble or process the LCD module.



- (7)LCD module should be used under recommended operating conditions shown in chapter 6 and 7.
- (8)Response time will be extremely slower at lower temperature than at specified temperature and LCD will show different color when at higher temperature. The phenomenon will disappear when returning to specified condition.
- (9)Foggy dew,moisture condensation or water droplets deposited on surface and contact terminals will cause polarizer stain or damage,the deteriorated display quality and electrochemical reaction then leads to the shorter life time and permanent damage to the module probably.Please pay attention to the environmental temperature and humidity.

2. Precautions for Storage

- (1)Please store LCD module in a dark place, avoid exposure to sunlight, the light of fluorescent lamp or any ultraviolet ray.
- (2)Keep the environment temperature at between 10° C and 35° C and at normal humidity. Avoid high temperature, high humidity or temperature below 0° C.
- (3)That keeps the LCD modules stored in the container shipped from supplier before using them is recommended.
- (4)Do not leave any article on the LCD module surface for an extended period of time.

3. Warranty period

Warrants for a period of 12 Months from the shipping date when stored or used under normal condition.



16. Package Specification

